



CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

Dual N-Channel Enhancement Mode Field Effect Transistor
VOLTAGE 40 Volts CURRENT 6.3 Ampere

CHM4228JPT

Lead free devices

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

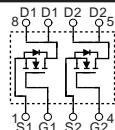
FEATURE

- * Small flat package. (SO-8)
- * High density cell design for extremely low R_{DS(ON)}.
- * Rugged and reliable.
- * High saturation current capability.

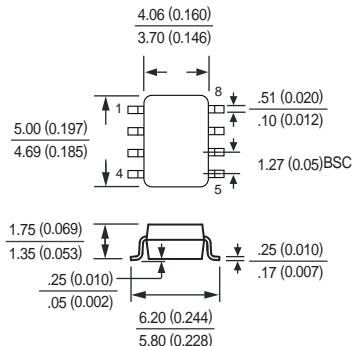
CONSTRUCTION

- * N-Channel Enhancement

CIRCUIT



SO-8



Dimensions in millimeters

SO-8

Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Symbol	Parameter	CHM4228JPT	Units
V _{DSS}	Drain-Source Voltage	40	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Maximum Drain Current - Continuous	6.3	A
	- Pulsed (Note 3)	20	
P _D	Maximum Power Dissipation	2000	mW
T _J	Operating Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C

Note : 1. Surface Mounted on FR4 Board , t <=10sec

2. Pulse Test , Pulse width <= 300us , Duty Cycle <= 2%

3. Repetitive Rating , Pulse width limited by maximum junction temperature

4. Guaranteed by design , not subject to production testing

Thermal characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1)	62.5	°C/W
2005-02			

RATING CHARACTERISTIC CURVES (CHM4228JPT)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 40 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
I_{GSSF}	Gate-Body Leakage	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0 \text{ V}$			+100	nA
I_{GSSR}	Gate-Body Leakage	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA

ON CHARACTERISTICS (Note 2)

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	1		3	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}, I_D=6\text{A}$		24	30	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_D=5\text{A}$		35	45	
g_{FS}	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_D = 6\text{A}$		9		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		1050		pF
C_{oss}	Output Capacitance			155		
C_{rss}	Reverse Transfer Capacitance			95		

SWITCHING CHARACTERISTICS (Note 4)

Q_g	Total Gate Charge	$V_{\text{DS}}=20\text{V}, I_D=6\text{A}$ $V_{\text{GS}}=10\text{V}$		20.6	27	nC
Q_{gs}	Gate-Source Charge			3.5		
Q_{gd}	Gate-Drain Charge			4		
t_{on}	Turn-On Time	$V_{\text{DD}}= 20\text{V}$ $I_D = 6.0\text{A}, V_{\text{GS}} = 10 \text{ V}$ $R_{\text{GEN}} = 3 \Omega$		14	30	nS
t_r	Rise Time			10	20	
t_{off}	Turn-Off Time			17	35	
t_f	Fall Time			18	35	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_s	Drain-Source Diode Forward Current	(Note 1)			1.0	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_s = 1.0\text{A}, V_{\text{GS}} = 0 \text{ V}$ (Note 2)			1.2	V